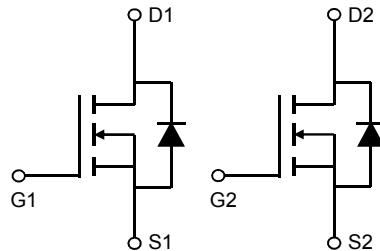
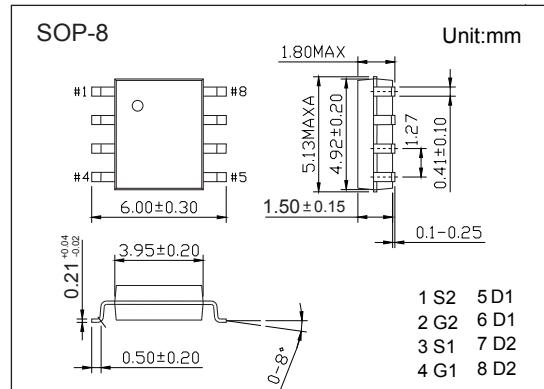


## Dual N-Channel MOSFET

### AO4892 (KO4892)

#### ■ Features

- $V_{DS} (V) = 100V$
- $I_D = 4A$  ( $V_{GS} = 10V$ )
- $R_{DS(ON)} < 68m\Omega$  ( $V_{GS} = 10V$ )
- $R_{DS(ON)} < 94m\Omega$  ( $V_{GS} = 4.5V$ )



#### ■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current	$I_D$	4	A
		3	
Pulsed Drain Current	$I_{DM}$	25	
Avalanche Current	$I_{AS}$	4	
Avalanche Energy	$E_{AS}$	0.8	mJ
Power Dissipation	$P_D$	2	W
		1.3	
Thermal Resistance.Junction- to-Ambient	$R_{thJA}$	62.5	$^\circ C/W$
		90	
Thermal Resistance.Junction- to-Lead	$R_{thJL}$	40	
Junction Temperature	$T_J$	150	$^\circ C$
Storage Temperature Range	$T_{stg}$	-55 to 150	

## Dual N-Channel MOSFET

### AO4892 (KO4892)

■ Electrical Characteristics  $T_a = 25^\circ\text{C}$

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{DSS}$	$I_D=250 \mu\text{A}, V_{GS}=0\text{V}$	100			V
Zero Gate Voltage Drain Current	$I_{DS(0)}$	$V_{DS}=100\text{V}, V_{GS}=0\text{V}$		1		$\mu\text{A}$
		$V_{DS}=100\text{V}, V_{GS}=0\text{V}, T_J=55^\circ\text{C}$		5		
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.7		2.8	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}, I_D=4\text{A}$		68		$\text{m}\Omega$
		$V_{GS}=10\text{V}, I_D=4\text{A}, T_J=125^\circ\text{C}$		126		
		$V_{GS}=4.5\text{V}, I_D=3\text{A}$		94		
On State Drain Current	$I_{D(on)}$	$V_{GS}=10\text{V}, V_{DS}=5\text{A}$	25			A
Forward Transconductance	$g_{FS}$	$V_{DS}=5\text{V}, I_D=4\text{A}$		12.5		S
Input Capacitance	$C_{iss}$	$V_{GS}=0\text{V}, V_{DS}=50\text{V}, f=1\text{MHz}$		415		$\text{pF}$
Output Capacitance	$C_{oss}$			32		
Reverse Transfer Capacitance	$C_{rss}$			3		
Gate Resistance	$R_g$	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	0.7		2.1	$\Omega$
Total Gate Charge (10V)	$Q_g$	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, I_D=4\text{A}$		6.5	12	$\text{nC}$
Total Gate Charge (4.5V)				3	6	
Gate Source Charge	$Q_{gs}$			1.5		
Gate Drain Charge	$Q_{gd}$			1.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, R_L=12.5\Omega, R_{GEN}=3\Omega$		4		$\text{ns}$
Turn-On Rise Time	$t_r$			2		
Turn-Off Delay Time	$t_{d(off)}$			15		
Turn-Off Fall Time	$t_f$			2		
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 4\text{A}, dI/dt = 500\text{A/us}$		16		$\text{nC}$
Body Diode Reverse Recovery Charge	$Q_{rr}$			44		
Maximum Body-Diode Continuous Current	$I_S$				2.5	A
Diode Forward Voltage	$V_{SD}$	$I_S=1\text{A}, V_{GS}=0\text{V}$			1	V

Note. The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.

■ Marking

Marking	4892 KA****
---------	----------------

## Dual N-Channel MOSFET

### AO4892 (KO4892)

■ Typical Characteristics

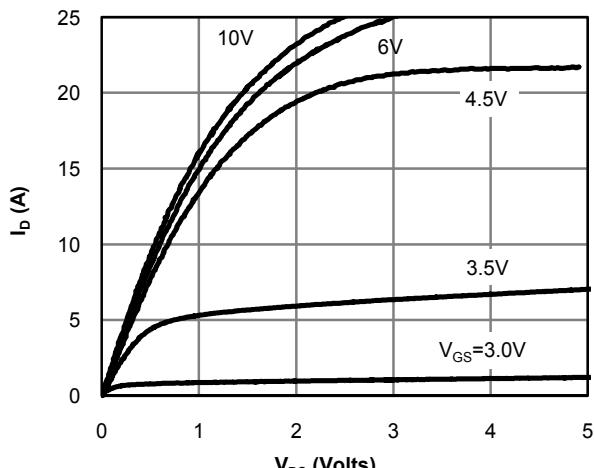


Fig 1: On-Region Characteristics (Note E)

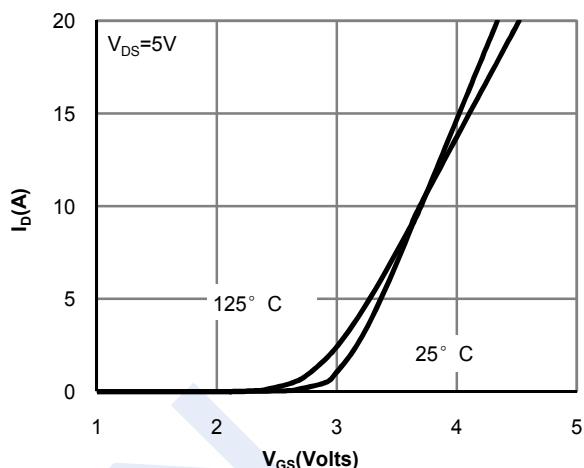


Figure 2: Transfer Characteristics (Note E)

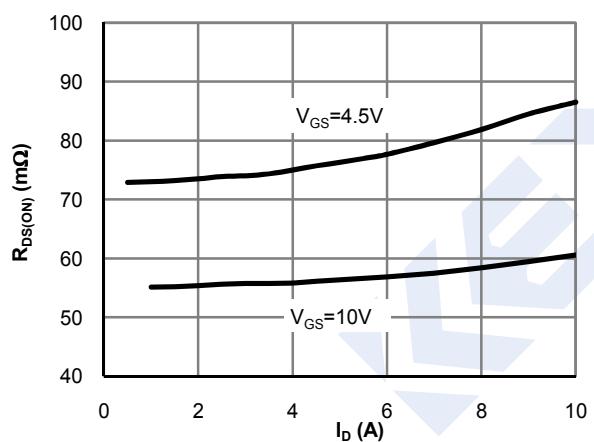


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

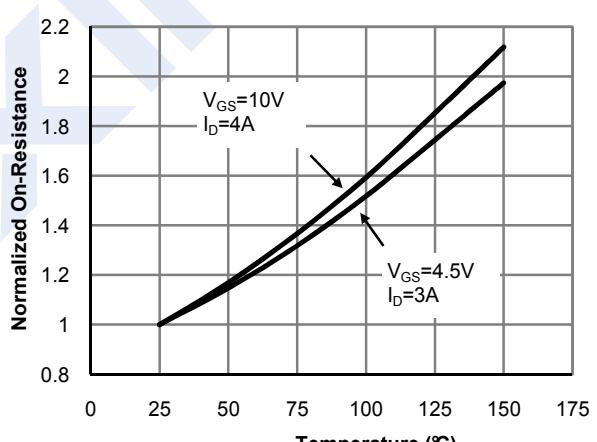


Figure 4: On-Resistance vs. Junction Temperature

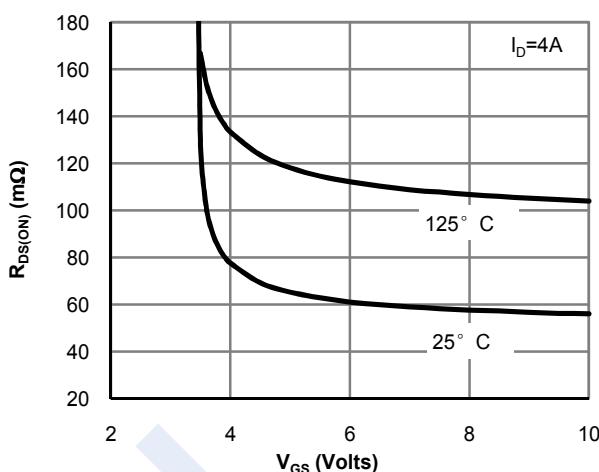


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

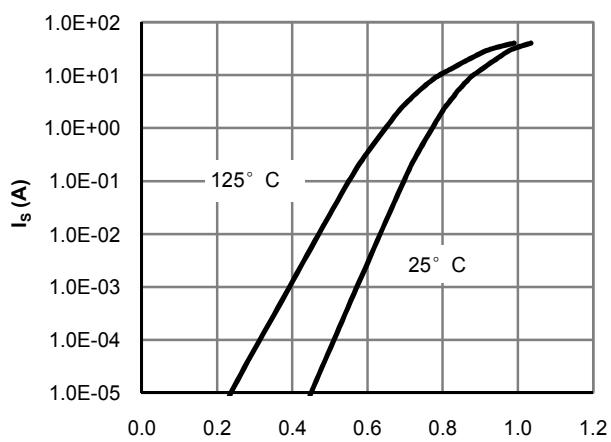


Figure 6: Body-Diode Characteristics (Note E)

## Dual N-Channel MOSFET

### AO4892 (KO4892)

■ Typical Characteristics

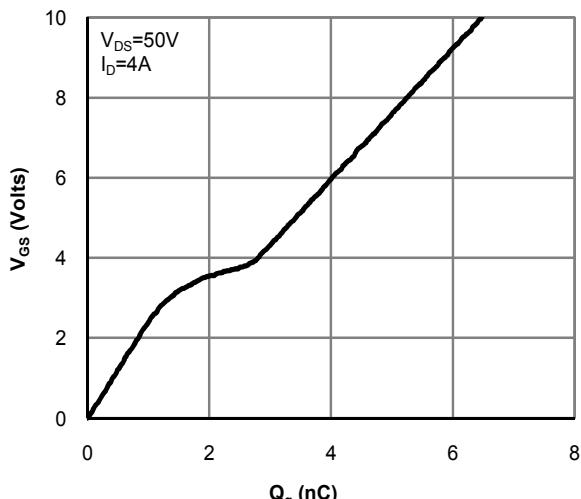


Figure 7: Gate-Charge Characteristics

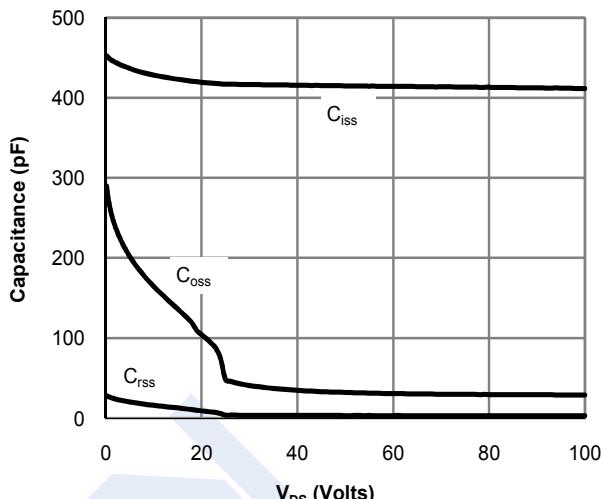


Figure 8: Capacitance Characteristics

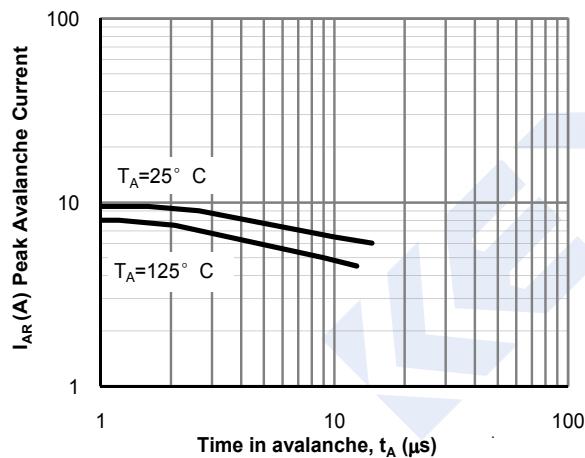


Figure 12: Single Pulse Avalanche capability

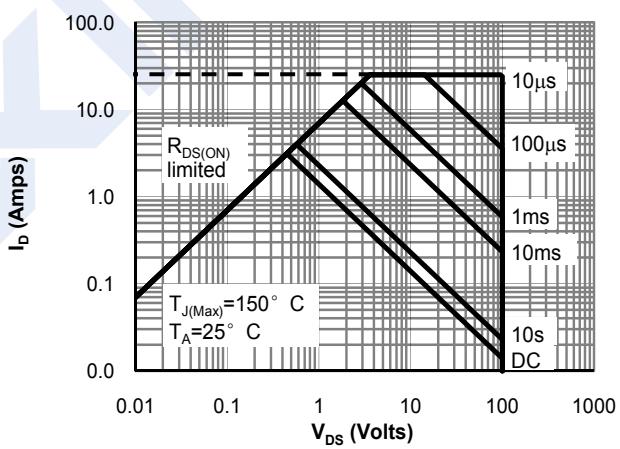


Figure 10: Maximum Forward Biased Safe Operating Area (Note F)

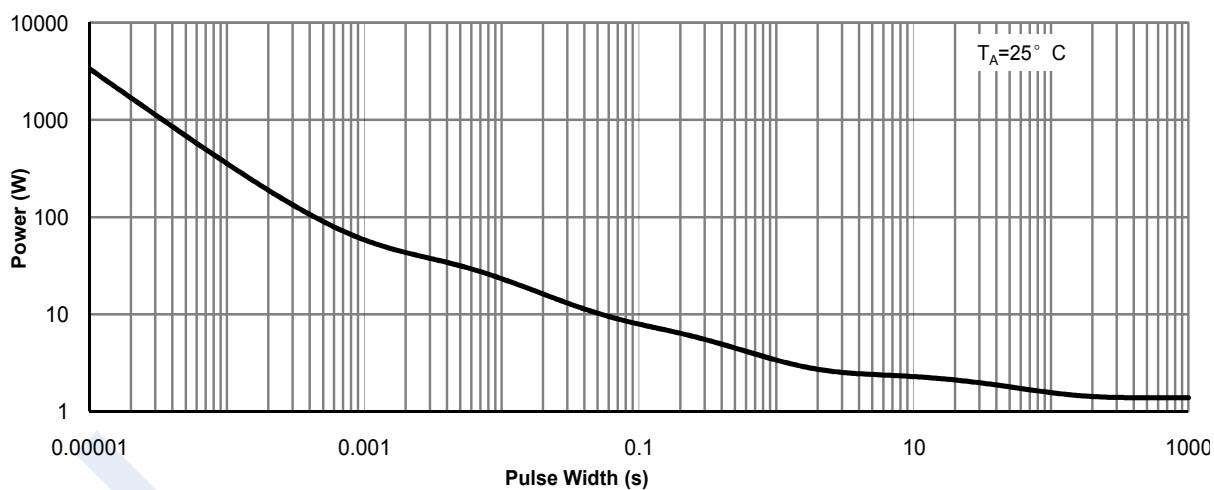


Figure 11: Single Pulse Power Rating Junction-to-Ambient (Note F)

## Dual N-Channel MOSFET

### AO4892 (KO4892)

#### ■ Typical Characteristics

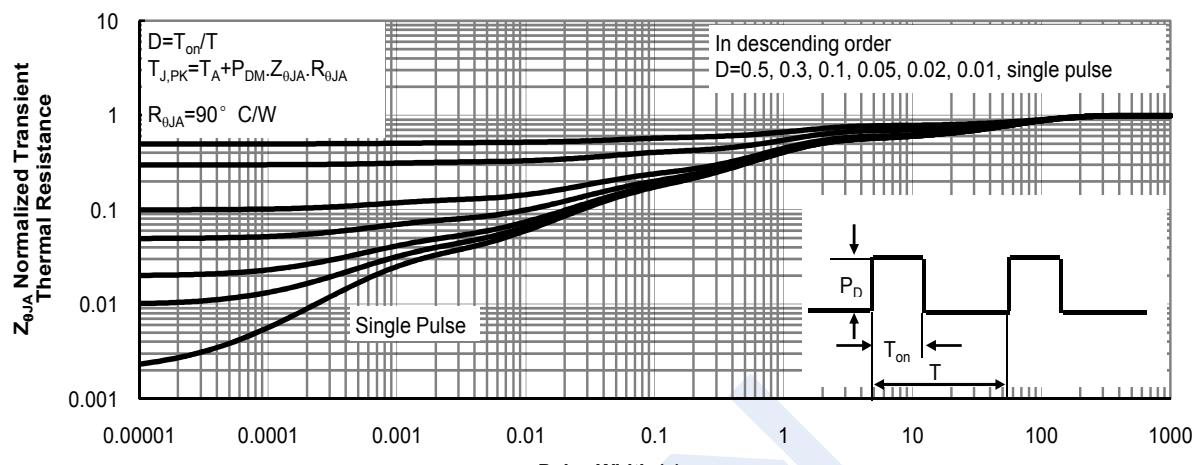


Figure 12: Normalized Maximum Transient Thermal Impedance (Note F)